

BT5.0 Low Energy Module – Industrial Grade



Key Features

- Bluetooth 4 and 5 low energy
- Powerful ARM Cortex-M4F processor
 - Clock speed: up to 48MHz
 - 352KB of In-System programmable flash with 8KB cache
 - 80KB SRAM
 - 8KB of cache SRAM
 - 2-Pin cJTAG and JTAG debugging
 - Support Over-the-Air upgrade (OTA)
 - Ultra-Low power sensor controller with 4KB of SRAM
 - 31 GPIOs
 - 4 x 32-Bit or 8 x 16-Bit general purpose timer
 - 12-Bit ADC, 200 kSamples/s, 8 channels
 - 2 x comparator with internal reference DAC
 - Programmable current source
 - 2 x UART
 - 2 x SSI (SPI, MICROWIRE, TI)
 - IIC, IIS
 - Real-Time-Clock (RTC)
 - AES 128- and 256-bit crypto accelerator
 - ECC and RSA public key hardware accelerator
 - SHA2 accelerator (Full suite up to SHA-512)
 - True Random Number Generator (TRNG)
 - Capacitive sensing, up to 8 channels
 - Integrated temperature and battery monitor
 - On-Chip buck DC/DC converter
- RF performance
 - TX power: -21dBm to 5dBm
 - RX sensitivity: up to -105dBm (LE coded PHY)
- Communication range: about 250 meters (LOS) – Long Range Mode
- Antenna: PCB antenna, 1.17 dBi gain
- Size: 22.95 mm x 15 mm x 2.1 mm (With Shielding)
- Ultra low power consumption:
 - Shutdown: 120nA (Wake up on external events)
 - Standby: 0.95uA (RTC running and RAM/CPU retention)



- RX current: 6.9mA
- TX current @ 0dBm: 7.4mA
- TX current @ 5dBm: 9.7mA
- Industrial grade operating temperature range from -40°C to +105°C
- Pin to pin compatible with BDE-BLEM205
- BQB, FCC, CE, RoHS compliant

Descriptions

BDE-BLEM205-IN is a Bluetooth 4 and 5 single-mode compliant Bluetooth low energy module targeted at low power sensors and PC/Phone accessories.

BDE-BLEM205-IN highly integrates Bluetooth Low Energy radio, stack, profile and applications in a SoC, without the need of using an external MCU. The module also offers flexible hardware interfaces for the sensor application.

It enables ultra-low power connectivity and data transfer for the applications that are sensitive to power consumption, size and cost.

Applications

- Medical devices
- Sports and fitness equipment
- Home electronics
- Mobile and PC accessories
- Industry automation

Electrical Characteristics

- Absolute maximum rating

Rating	Min	Typ	Max	Unit	Notes
Storage Temperature	-40	-	125	°C	
VDD	-0.3	-	4.1	V	
Other Digital Terminals	-0.3	-	$V_{DD5}+0.3 \leq 4.1$	V	
Voltage on ADC input	-0.3	-	V _{DD5}	V	Voltage scaling enabled
	-0.3	-	1.49	V	Voltage scaling disabled, internal reference
	-0.3	-	V _{DD5} /2.9	V	Voltage scaling disabled, V _{DD5} as reference
RF pin	-	-	5	dBm	

- Recommended operating conditions

Rating	Min	Typ	Max	Unit
Operating Temperature	-40	-	105	°C
VDD	1.8	3.3	3.8	V

Pinout

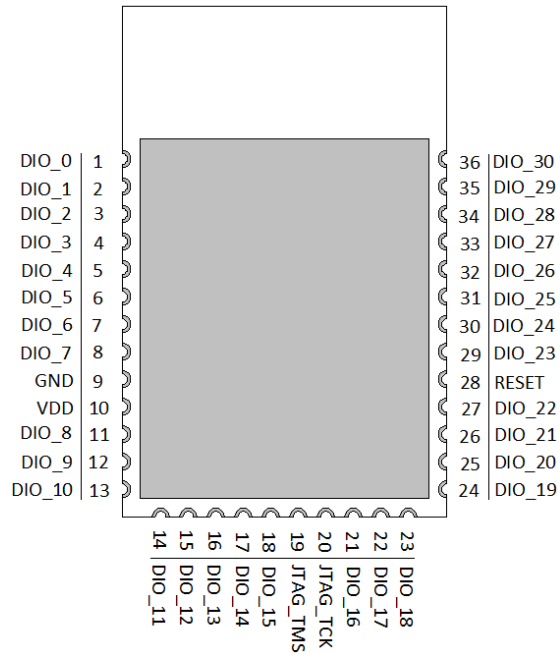


Fig. 2: The pinout of BDE-BLEM205-IN (TOP VIEW)

Table 1: Pin definitions of BDE-BLEM205-IN

Pin Number	Pin Name	Definitions
1	DIO_0	GPIO, Sensor Controller
2	DIO_1	GPIO, Sensor Controller
3	DIO_2	GPIO, Sensor Controller
4	DIO_3	GPIO, Sensor Controller
5	DIO_4	GPIO, Sensor Controller
6	DIO_5	GPIO, Sensor Controller, high-drive capability
7	DIO_6	GPIO, Sensor Controller, high-drive capability
8	DIO_7	GPIO, Sensor Controller, high-drive capability
9	GND	Power Ground
10	VDD	Power Supply
11	DIO_8	GPIO
12	DIO_9	GPIO
13	DIO_10	GPIO
14	DIO_11	GPIO
15	DIO_12	GPIO
16	DIO_13	GPIO
17	DIO_14	GPIO
18	DIO_15	GPIO
19	JTAG_TMS	JTAG TMS, high-drive capability
20	JTAG_TCK	JTAG TCK
21	DIO_16	GPIO, JTAG_TDO, high-drive capability

22	DIO_17	GPIO, JTAG_TDI, high-drive capability
23	DIO_18	GPIO
24	DIO_19	GPIO
25	DIO_20	GPIO
26	DIO_21	GPIO
27	DIO_22	GPIO
28	RESET	Reset, active-low
29	DIO_23	GPIO, Sensor Controller, Analog
30	DIO_24	GPIO, Sensor Controller, Analog
31	DIO_25	GPIO, Sensor Controller, Analog
32	DIO_26	GPIO, Sensor Controller, Analog
33	DIO_27	GPIO, Sensor Controller, Analog
34	DIO_28	GPIO, Sensor Controller, Analog
35	DIO_29	GPIO, Sensor Controller, Analog
36	DIO_30	GPIO, Sensor Controller, Analog

Overall Dimensions

Fig. 3 shows the overall dimensions of BDE-BLEM205-IN. The module measures 22.95mm long by 15mm wide by 2.1mm high with the shield.

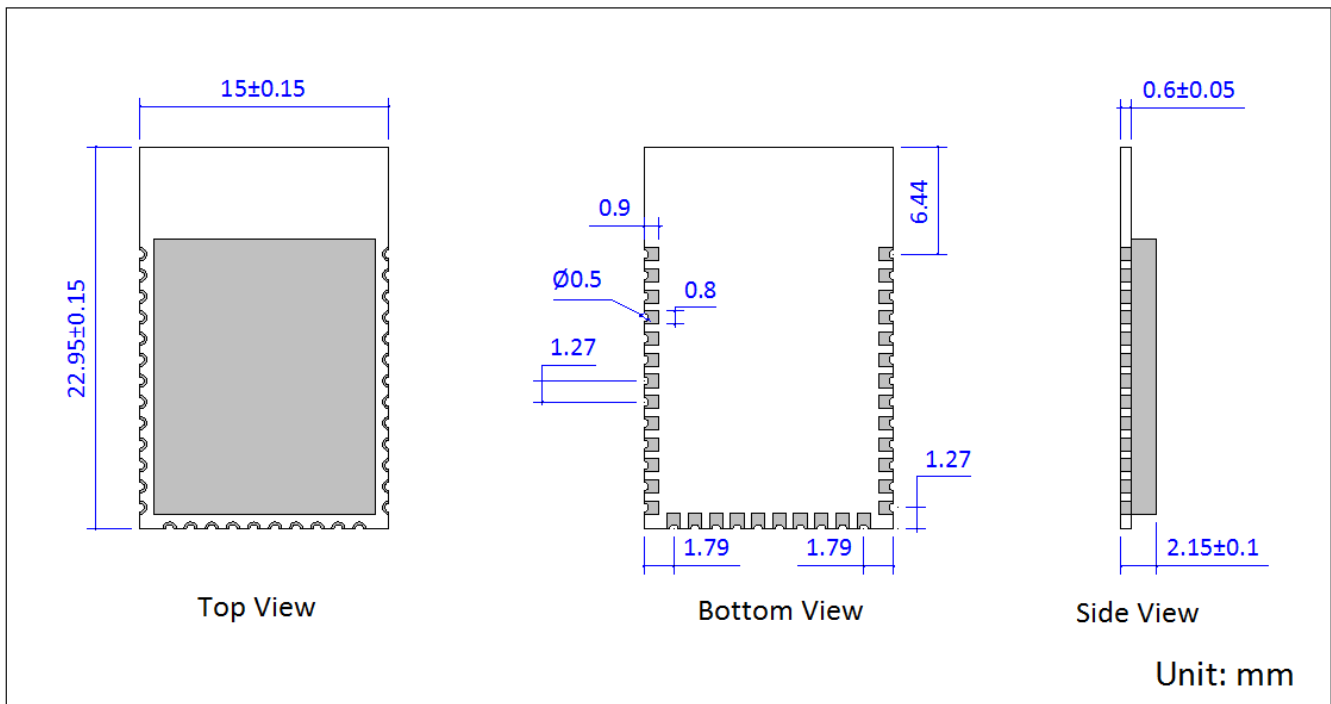


Fig. 3: Overall Dimensions of BDE-BLEM205-IN

Module Location

In order to get a fine performance when integrate the module to your product, it is advised to use the recommended module location to the respective PCB.

■ Location in X-Y plane

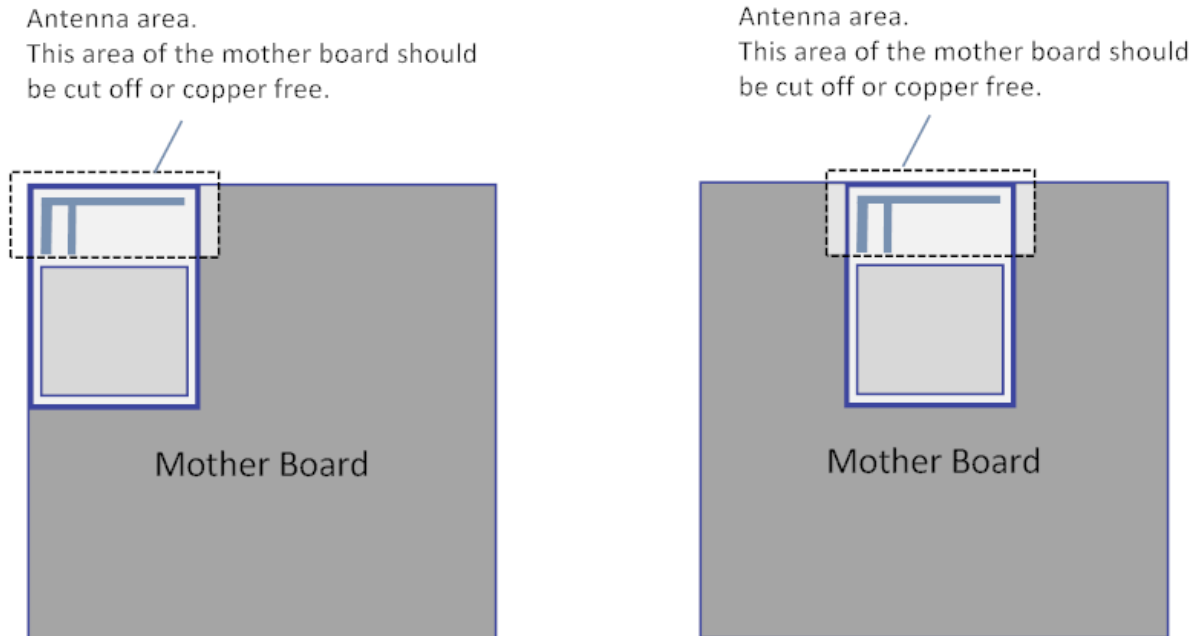


Fig. 4: Recommended location in X-Y plane

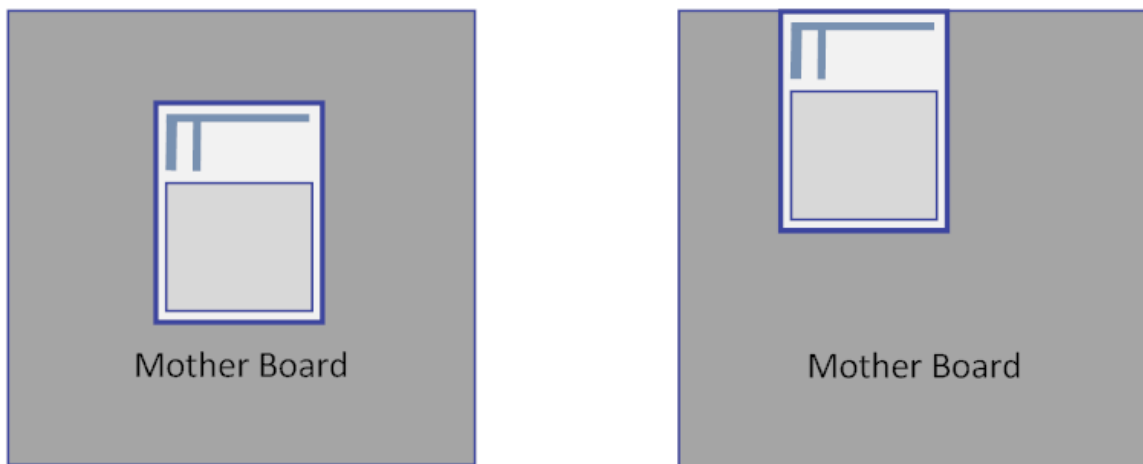


Fig. 5: Not recommended location in X-Y plane

■ Location in Z plane

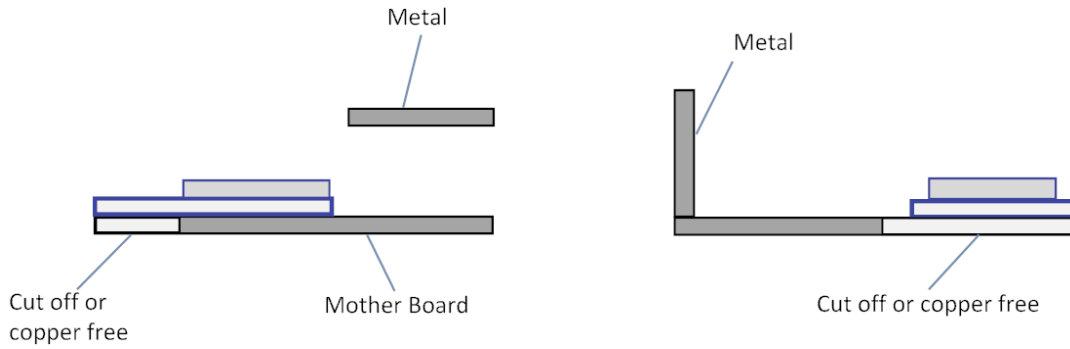


Fig. 6: Recommended location in Z plane

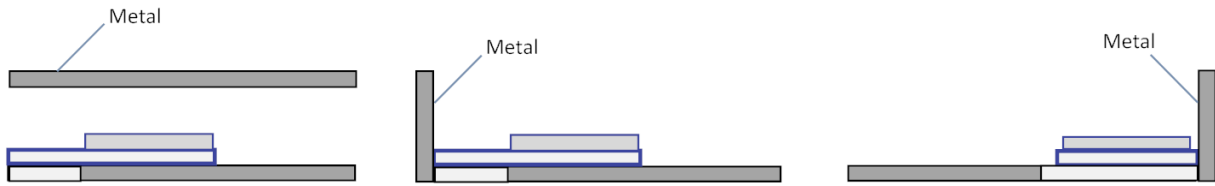


Fig. 7: Not recommended location in Z plane

Typical Solder Reflow Profile

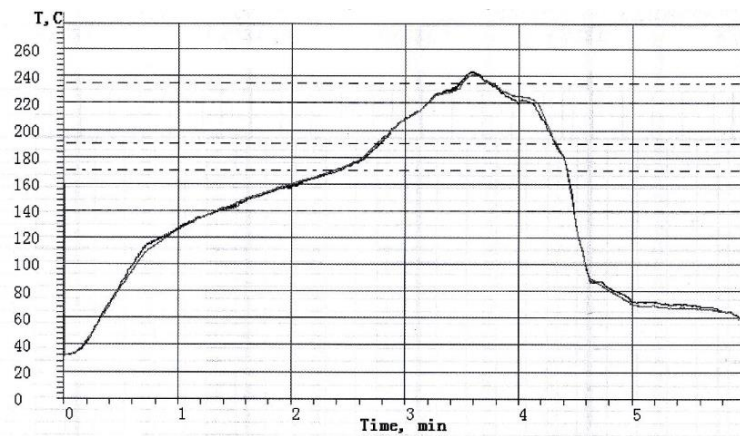


Fig. 8: Typical Solder Reflow Profile

Package Information



Fig. 9: Package

FCC Warning

Integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01

1. List of applicable FCC rules

FCC Part 15.247

2. Specific operational use conditions

This transmitter/module and its antenna(s) must not be co-located or operating in conjunction with any transmitter. This information also extends to the host manufacturer's instruction manual.

3. Limited module procedures

Not applicable

4. Trace antenna designs

It is "not applicable" as trace antenna which is not used on the module.

5. RF exposure considerations

This equipment complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This compliance to FCC radiation exposure limits for an uncontrolled environment, and minimum of 20cm separation between antenna and body.

The host product manufacturer would provide the above information to end users in their end-product manuals.

6. Antennas



PCB Antenna; 1.71dBi; 2402MHz ~ 2480MHz

7. Label and compliance information

The end product must carry a physical label or shall use e-labeling followed KDB784748D01 and KDB 784748 stating "Contains Transmitter Module FCC ID: 2ABRU-BLEM205IN".

8. Information on test modes and additional testing requirements

For more information on testing, please contact the manufacturer.

9. Additional testing, Part 15 Subpart B disclaimer

The modular transmitter is only FCC authorized for the specific rule parts (FCC Part 15.247) listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed when contains digital circuitry.

FCC Statements

(OEM) Integrator has to assure compliance of the entire end-product incl. the integrated RF Module. For 15 B (§15.107 and if applicable §15.109) compliance, the host manufacturer is required to show compliance with 15 while the module is installed and operating.

Furthermore the module should be transmitting and the evaluation should confirm that the module's intentional emissions (15C) are compliant (fundamental / out-of-band). Finally the integrator has to apply the appropriate equipment authorization (e.g. Verification) for the new host device per definition in §15.101.

Integrator is reminded to assure that these installation instructions will not be made available to the end-user of the final host device.

The final host device, into which this RF Module is integrated" has to be labeled with an auxiliary label stating the FCC ID of the RF Module, such as "Contains FCC ID: **2ABRU-BLEM205IN**

"This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions:

(1) this device may not cause harmful interference, and



(2) this device must accept any interference received, including interference that may cause undesired operation."

"Changes or modifications to this unit not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment."

The Integrator will be responsible to satisfy SAR/ RF Exposure requirements, when the module integrated into the host device.

Module statement

The single-modular transmitter is a self-contained, physically delineated, component for which compliance can be demonstrated independent of the host operating conditions, and which complies with all eight requirements of § 15.212(a)(1) as summarized below.

- 1) The radio elements have the radio frequency circuitry shielded.
- 2) The module has buffered modulation/data inputs to ensure that the device will comply with Part 15 requirements with any type of input signal.
- 3) The module contains power supply regulation on the module.
- 4) The module contains a permanently attached antenna.
- 5) The module demonstrates compliance in a stand-alone configuration.
- 6) The module is labeled with its permanently affixed FCC ID label.
- 7) The module complies with all specific rules applicable to the transmitter, including all the conditions provided in the integration instructions by the grantee.
- 8) The module complies with RF exposure requirements.



NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

IC Statements

The final host device, into which this RF Module is integrated" has to be labeled with an auxiliary label stating the IC of the RF Module, such as" Contains transmitter module IC: **2ABRU-BLEM205IN**

Le périphérique hôte final, dans lequel ce module RF est intégré "doit être étiqueté avec une étiquette auxiliaire indiquant le CI du module RF, tel que" Contient le module émetteur IC: **25657-BLEM205**

This device contains licence-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's licence-exempt RSS(s). Operation is subject to the following two conditions:

- (1) This device may not cause interference.
- (2) This device must accept any interference, including interference that may cause undesired operation of the device.



L'émetteur/récepteur exempt de licence contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) L'appareil ne doit pas produire de brouillage;
- (2) L'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

RF Exposure Warning Statements:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment.

This equipment shall be installed and operated with minimum distance 20cm between the radiator & body.

Radio Frequency Exposure Statement for IC:

The device has been evaluated to meet general RF exposure requirements. The device can be used in mobile exposure conditions. The min separation distance is 20cm.

Déclaration d'exposition aux radiofréquences pour IC:

L'appareil a été évalué pour répondre aux exigences générales en matière d'exposition aux RF. L'appareil peut être utilisé dans des conditions d'exposition mobiles. La distance de séparation minimale est de 20 cm.

Contacts

Guangzhou BDE Technology Inc.

Address: B2-403, Chuangyi Building, 162 Science Ave, Huangpu District, Guangzhou, 510663, China

494 E Thornhill Ln, Palatine, IL 60074, USA

Tel: +86-020-28065335 Fax: +86-020-28065338

Website: www.bdecomm.com Email: info@bdecomm.com